

A

B

C

D

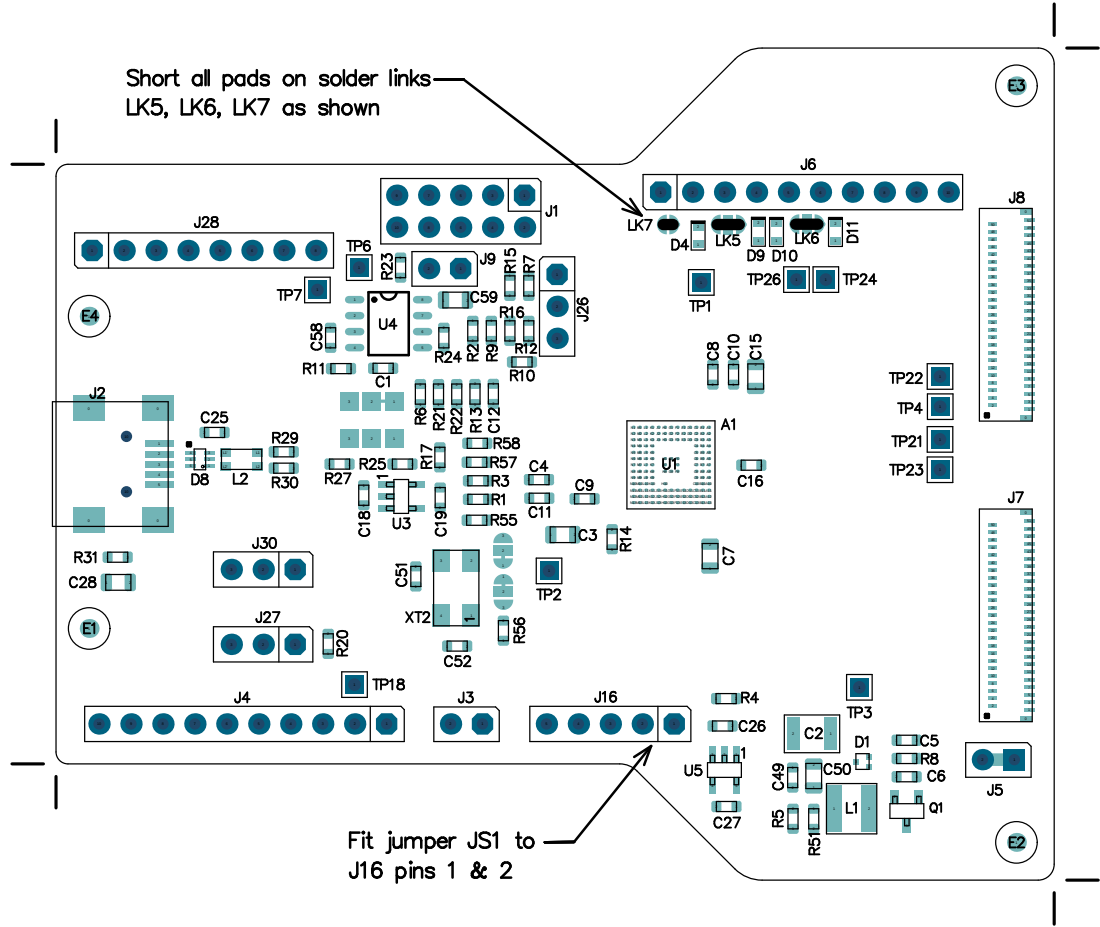
A

B

C

D

REV	ECO	Comments	Date
A0	N/A	First Issue	29th Sept 2014
B0	N/A	Added D4 & D9–11, MHCP branding	23rd Nov 2017
1	N/A	CE, WEEE & RoHS markings added	16th Oct 2018
2	N/A	Q1, U3, U5 now MCHP parts Board number changed per Dev Tools ATM	10th Jan 2019

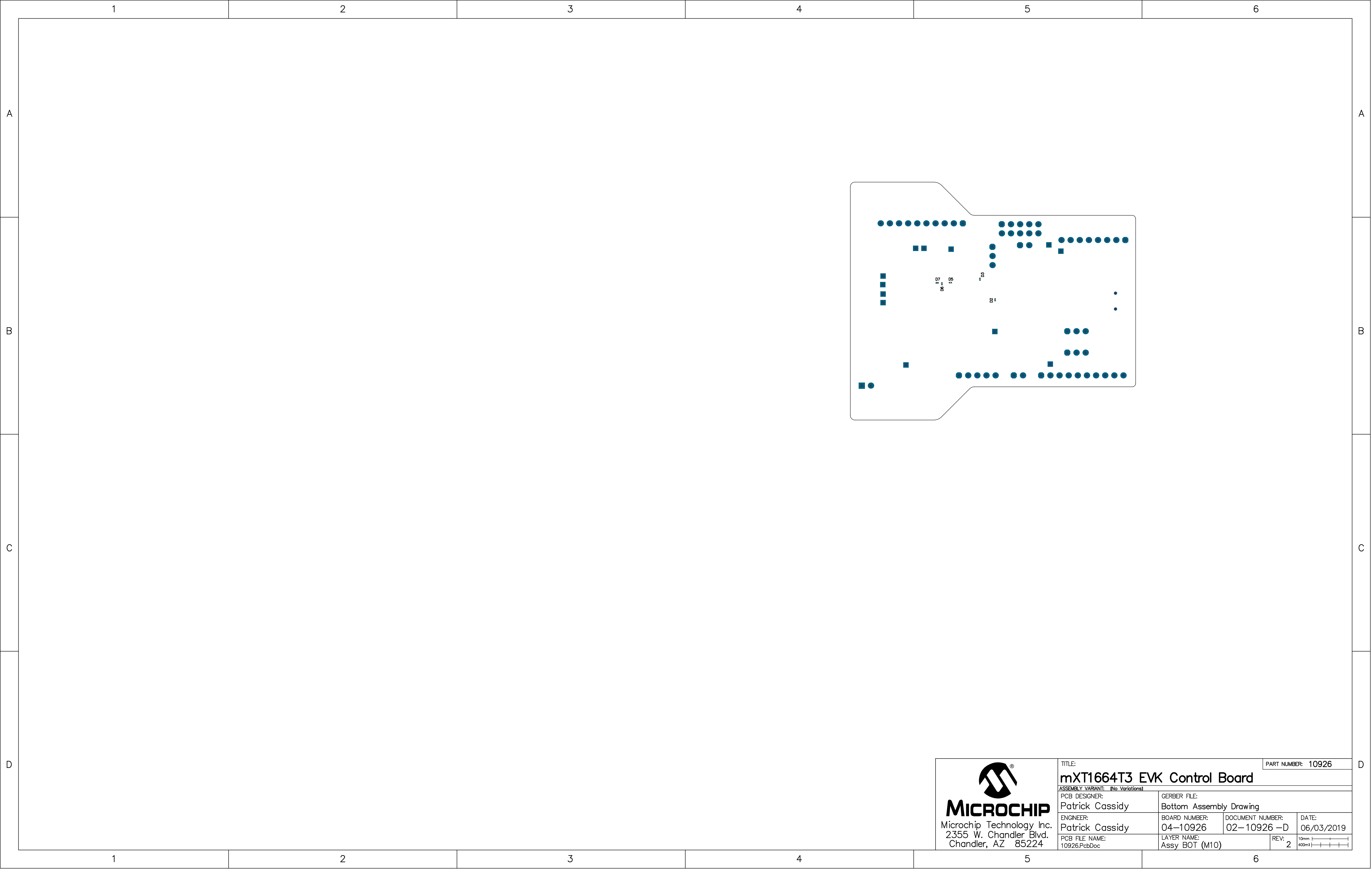


ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
7. PLACE LABEL ON THE LOCATION INDICATED.

 MICROCHIP Microchip Technology Inc. 2355 W. Chandler Blvd. Chandler, AZ 85224	TITLE: mXT1664T3 EVK Control Board			PART NUMBER: 10926
	ASSEMBLY VARIANT: (No Variations)			
	PCB DESIGNER: Patrick Cassidy		GERBER FILE: Top Assembly Drawing	
	ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-10926	DOCUMENT NUMBER: 02-10926 -D
	PCB FILE NAME: 10926.PcbDoc		LAYER NAME: Assy TOP (M11)	DATE: 06/03/2019

REV: 2	10mm 400mil
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MICROCHIP
Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224

TITLE:		PART NUMBER: 10926	
mXT1664T3 EVK Control Board			
ASSEMBLY VARIANT: [No Variations]			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Bottom Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04—10926	DOCUMENT NUMBER: 02— 10926 —D
PCB FILE NAME: 10926.PcbDoc		LAYER NAME: Assy BOT (M10)	DATE: 06/03/2019
		REV: 2	10mm 400mil

10926-2

